

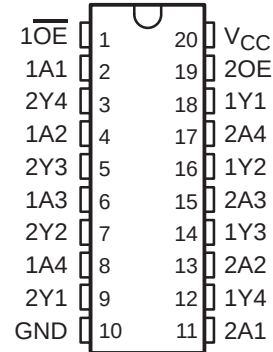
- BiCMOS Design Significantly Reduces I_{CCZ}
- ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015; Exceeds 200 V Using Machine Model ($C = 200$ pF, $R = 0$)
- Open-Collector Outputs Drive Bus Lines or Buffer Memory Address Registers
- Package Options Include Plastic Small-Outline (DW) Packages and Standard Plastic 300-mil DIPs (N)

description

This octal buffer and line driver is designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. This device provides complementary output-enable (OE and $\overline{OE}$) inputs and noninverting outputs.

The SN74BCT757 is characterized for operation from 0°C to 70°C.

DW OR N PACKAGE
(TOP VIEW)



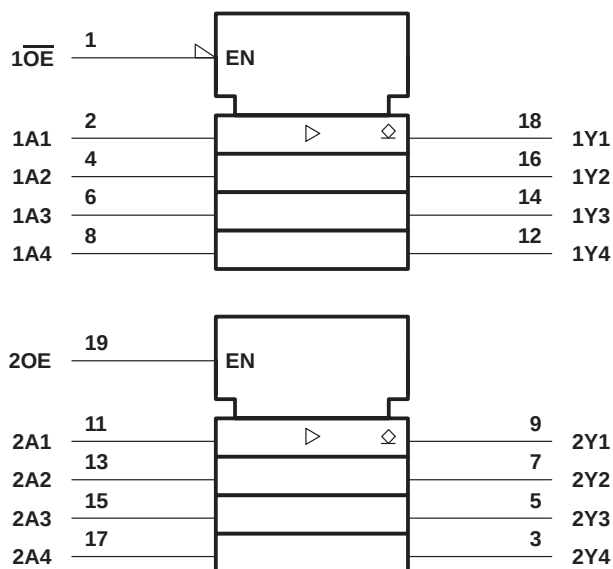
FUNCTION TABLES

INPUTS		OUTPUT 1Y
$\overline{1OE}$	1A	
H	X	H
L	L	L
L	H	H

INPUTS		OUTPUT 2Y
2OE	2A	
L	X	H
H	L	L
H	H	H

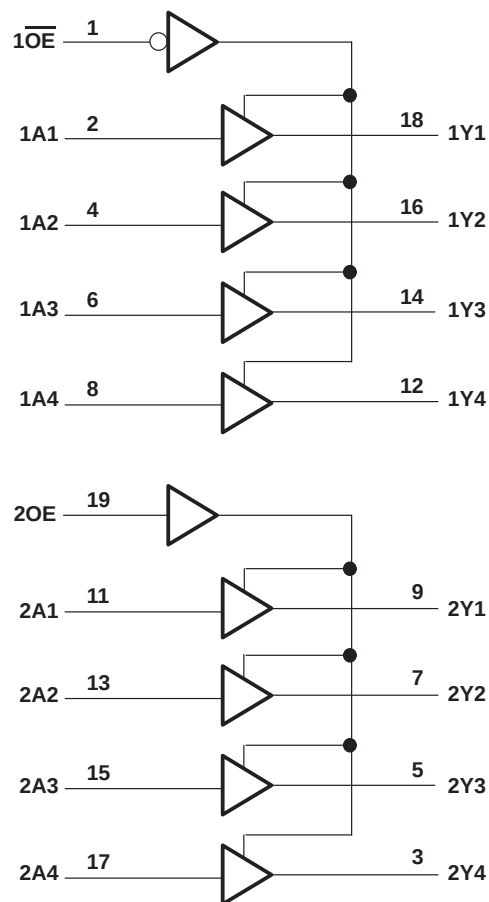
SN74BCT757
OCTAL BUFFER/DRIVER
WITH OPEN-COLLECTOR OUTPUTS
 SCBS041D – NOVEMBER 1989 – REVISED NOVEMBER 1993

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V_{CC}	–0.5 V to 7 V
Input voltage range, V_I	–0.5 V to 7 V
Input current range, I_I	–30 mA to 5 mA
Voltage range applied to any output in the disabled or power-off state, V_O	–0.5 V to 5.5 V
Voltage range applied to any output in the high state, V_O	–0.5 V to V_{CC}
Current into any output in the low state, I_O	128 mA
Operating free-air temperature range	0°C to 70°C
Storage temperature range	–65°C to 150°C

‡ Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 1)

	MIN	NOM	MAX	UNIT
V_{CC} Supply voltage	4.5	5	5.5	V
V_{IH} High-level input voltage	2			V
V_{IL} Low-level input voltage			0.8	V
V_{OH} High-level output voltage			5.5	V
I_{IK} Input clamp current			–18	mA
I_{OL} Low-level output current			64	mA
T_A Operating free-air temperature	0		70	°C

NOTE 1: Unused or floating inputs must be held high or low.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		MIN	TYP [†]	MAX	UNIT
V_{IK}	$V_{CC} = 4.5\text{ V}$,	$I_I = -18\text{ mA}$			–1.2	V
V_{OL}	$V_{CC} = 4.5\text{ V}$,	$I_{OL} = 64\text{ mA}$		0.42	0.55	V
I_I	$V_{CC} = 5.5\text{ V}$,	$V_I = 7\text{ V}$			0.1	mA
I_{IH}	$V_{CC} = 5.5\text{ V}$,	$V_I = 2.7\text{ V}$			20	μA
I_{IL}	$V_{CC} = 5.5\text{ V}$,	$V_I = 0.5\text{ V}$			–1	mA
I_{OH}	$V_{CC} = 4.5\text{ V}$,	$V_{OH} = 5.5\text{ V}$			0.1	mA
I_{CC}	$V_{CC} = 5.5\text{ V}$,	Outputs open	Outputs high		34	mA
			Outputs low		77	
			OE and $\overline{\text{OE}}$ inactive		10	
C_i	$V_{CC} = 5\text{ V}$,	$V_I = 2.5\text{ V}$ or 0.5 V		6		pF
C_o	$V_{CC} = 5\text{ V}$,	$V_O = 2.5\text{ V}$ or 0.5 V		4		pF

[†] All typical values are at $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50\text{ pF}$ (unless otherwise noted) (see Note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$			MIN	MAX	UNIT
			MIN	TYP	MAX			
t_{PLH}	A	Y	6.9	8.3	9.6	6.6	10.1	ns
t_{PHL}			2.4	4.2	6	2	6.6	
t_{PLH}	2OE	Y	11	14.8	17.9	10.8	19.7	ns
t_{PHL}			2.9	4.6	6.2	2.6	6.9	
t_{PLH}	1OE	Y	11.4	13.9	16.1	10	18	ns
t_{PHL}			4.4	6.1	7.8	4	8.5	

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

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